

Features & Benefits

- Thermal resistance 76μm, 0.17°C-cm²/W (0.026°C-in²/W)
 - (76μm thickness)
- Product Thermal Conductivity of 7.5 W/m-K
- High Voltage Strength
- High temperature applications
- Lead-free solder compatible
- Eutectic AuSn compatible
- RoHS compliant and environmentally green
- Available on aluminum and copper base substrates
 - Other substrate materials may be available.

Thermal Clad Metal Core PCB's (MCPCB's) minimize thermal impedance and conducts heat more efficiently than standard printed wiring boards (PWB's). These substrates are more mechanically robust than Direct Bond Copper (DBC) construction.

The differentiating technology of Thermal Clad resides in the dielectric. This datasheet highlights the performance characteristics of Thermal Clad HPL dielectric.

Applications

- High power density applications where achieving low thermal resistance is required.
- Automotive high voltage power modules
- Power conversion
- LED headlight & foglamps
- High power LED architectural lighting and UV LED
- Motor drives
- Solid state relays

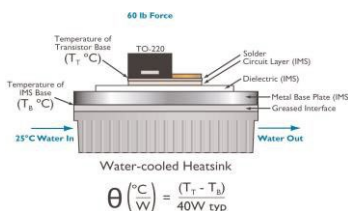
Configurations

Base Metal	Thickness mm (mil)
5052 Aluminum	0.8 (32), 1.0 (40)*, 1.5 (59)*, 2.0 (80), 3.2 (125)
6061 Aluminum	0.8 (32), 1.0 (40)*, 1.5 (59)*, 2.0 (80), 3.2 (125), 4.8 (190)
4045 Aluminum	1.5 (59), 2.0 (80)
Copper C1100	0.5 (20), 0.8 (32), 1.0 (40)*, 1.58 (62)*, 3.2 (125)***
Copper Foil	Weight oz (thickness μm)
ED Copper:	1oz (35), 2oz (70), 3oz (105), 4oz (140), 6oz (210)
RA Copper:	8oz (280), 10oz (350)

* Most common thicknesses.

** Other thicknesses and alloys may be available. Please contact TCLAD sales department for more information.

*** exclude in combination with 0.5 or 1oz Copper foil.



HPL Dielectric

Item	Thickness	Unit	Value	Method
Thermal Properties				
Product Thermal Conductivity		W/m-K	7.5	MET 5.4-01-40000
Dielectric Thermal Conductivity		W/m-K	3.0	ASTM D5470
Thermal Resistance	50µm (2mil)	°C-cm²/W	0.17 (0.026)	ASTM D5470
	76µm (3mil)		0.18 (0.028)	
	100µm (4mil)	(°C-in²/W)	0.20 (0.031)	
	150µm (6mil)		0.25 (0.039)	
Thermal Impedance	50µm (2mil)	°C/W	0.40	MET 5.4-01-40000
	76µm (3mil)		0.42	
	100µm (4mil)		0.47	
	150µm (6mil)		0.58	
Electrical Properties				
Dielectric Constant		-	4.2	IPC-TM-650 2.5.5.9
Dissipation Factor	100µm (4mil)	1MHz	0.015	IPC-TM-650 2.5.5.9
Capacitance	100 µm (4 mil)	pF	36	IPC-TM-650 2.5.5.9
Volume Resistivity		Ω-m	10¹⁴	ASTM D257
Surface Resistivity		Ω/sq	10¹³	ASTM D257
Breakdown Voltage	50µm (2mil)	KVAC	7.7	ASTM D149
	76µm (3mil)		9.7	
	100µm (4mil)		12.2	
	150µm (6mil)		17.4	
Mechanical Properties				
Color		-	Off-white	Visual
Peel Strength @ 25°C		N/mm ((lb/in)	0.9 (5)	ASTM D2861
Glass Transition (Tg		°C	185	ASTM E1356
CTE in X,Y/Z Axis <Tg		µm/m°C	35	ASTM D3386
CTE in X,Y/Z Axis >Tg		µm/m°C	85	ASTM D3386
Storage Modulus)		GPa	17/12	ASTM D4065
Decomposition Temperature (2% loss)		°C	370	IPC TM-650 2.4.24.6
Decomposition Temperature (5% loss)		°C	400	IPC TM-650 2.4.24.6
Chemical Properties				
Water Vapor Retention		% Wt.	0.11	ASTM E595
Out-Gassing Total Mass Loss		% Wt.	0.15	ASTM E595
Collect Volatile Condensable Material		% Wt.	< 0.01	ASTM E595
Agency Ratings & Durability UL: E121882				
UL Maximum Operating Temperature (MOT)		°C	140	UL 746
UL Flammability		-	V-0	UL 94
UL Comparative Tracking Index		(CTI)	0 / 600	ASTM D3638/ IEC 60112
Solder Limit Rating		°C	325	UL 746

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